

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	88	(adhes\$3 near metal) and (solder near wet\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:03
L2	25	("3809625" "4661375" "4763829" "4840820" "4927505" "4950623" "4970571" "4982265" "5169680" "5308796" "5316788" "5376584" "5403671" "5461261" "5491364" "5617990" "5675889" "5736456" "5773359" "5795619" "5851911" "5903058" "5910354" "6091141").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 14:30
L3	47	("3809625" "4188417" "4316208" "4661375" "4927505" "4970571" "5104324" "5118027" "5140405" "5169680" "5207598" "5259793" "5269453" "5308796" "5341564" "5367196" "5461261" "5483741" "5519332" "5531021" "5531942" "5532612" "5541525" "5547740" "5559444" "5578526" "5578527" "5592736" "5593927" "5633122" "5661042" "5668059" "5674785" "5675889" "5686317" "5696033" "5739585" "5756370" "5767443" "5786632" "5789278" "5801452" "5834799" "5859470" "5910640" "5920125").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 14:35
L4	4	("5162257" "5391514" "5470787" "5634268").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 15:22
L5	5301	solder with (metal near (layer film))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 15:23
L6	2232	solder with (metal near (layer film)) with (surface (die chip))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 15:24
L7	859	6 and (lid cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 15:24
L8	1	7 and (melt\$3 near2 solder near2 (lid cover) near2 (die chip))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 15:26

L9	322	7 and (melt\$3 near2 solder)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 15:26
L10	187	9 and ((die chip) with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:00
L11	17	("4561011" "4827376" "5098609" "5276289" "5396403" "5587882" "5623394" "5672548" "5744863" "5880524" "5905636" "6091603" "6218730" "6281573" "6292369" "6294408" "6372337").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 15:59
L12	21	("4748495" "5276586" "5366688" "5372296" "5434745" "5465470" "5528462" "5545473" "5552635" "5585671" "5591034" "5604978" "5623394" "5789810" "5881944" "5881945" "5889323" "5982038" "6041501" "6091603" "6218730").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 15:59
L13	30	("4323914" "5094769" "5098609" "5167851" "5323294" "5387815" "5396403" "5552635" "5572070" "5585671" "5610442" "5621615" "5642262" "5706579" "5710459" "5717245" "5724729" "5745344" "5757620" "5819401" "5821161" "5825087" "5834337" "5881944" "5881945" "5885848" "5898219" "5907474" "5956576" "5990418").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 15:59
L14	13	("4291815" "4626460" "4746583" "4833102" "4839716" "4999699" "5064782" "5064968" "5258576" "5414300" "5471027" "5710459" "5744863").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:01
L15	35	("4323914" "5094769" "5098609" "5167851" "5323294" "5387815" "5396403" "5552635" "5572070" "5585671" "5610442" "5621615" "5642262" "5706579" "5710459" "5717245" "5724729" "5745344" "5757620" "5819401" "5821161" "5825087" "5834337" "5881944" "5881945" "5885848" "5898219" "5907474" "5956576" "5990418" "6037658" "6046498" "6081428" "6084775" "6091603").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:36
L16	13	("5200365" "5276586" "5311402" "5329160" "5471027" "5585671" "5587882" "5777847" "5889652" "5956576" "5982038" "6008536" "6088915").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:39

L17	3	("4034468" "4034469" "4233645").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:48
L18	47	("3809625" "4188417" "4316208" "4661375" "4927505" "4970571" "5104324" "5118027" "5140405" "5169680" "5207598" "5259793" "5269453" "5308796" "5341564" "5367196" "5461261" "5483741" "5519332" "5531021" "5531942" "5532612" "5541525" "5547740" "5559444" "5578526" "5578527" "5592736" "5593927" "5633122" "5661042" "5668059" "5674785" "5675889" "5686317" "5696033" "5739585" "5756370" "5767443" "5786632" "5789278" "5801452" "5834799" "5859470" "5910640" "5920125").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:53
L19	42	("3650450" "3809625" "4188417" "4316208" "4661375" "4840820" "4927505" "4970571" "5104324" "5169680" "5249450" "5259793" "5269453" "5308796" "5341564" "5367196" "5376584" "5461261" "5483741" "5519332" "5531021" "5531942" "5532612" "5547740" "5559444" "5578526" "5592736" "5593927" "5617990" "5633122" "5674785" "5675889" "5736456" "5789278" "5795619" "5851911" "5872400" "5888849" "5889327" "5903058" "5910640").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 16:55
L20	370	(lid cover) with solder with (die chip) with (metal conduct\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:08
L21	11	20 and (adhes\$3 near metal)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:13
L22	30	20 and (solder near wet\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 18:05
L23	10	(lid cover) with solder with (die chip) with ((metal conduct\$3) near (lare film))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:09

L24	61	(lid cover) with solder with (die chip) with ((metal conduct\$3) near (layer film))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:13
L25	1275	(lid cover) with solder with (die chip)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:12
L26	442	25 and ((metal conduct\$3) near (layer film))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:13
L27	16	26 and (adhes\$3 near metal)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 17:13
L28	9	("5291064" "5508230" "5895972" "5907189" "5985412" "6118177" "6245249" "6317326" "6390181").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 17:15
L29	8	("5268814" "5285351" "5291064" "5345107" "5528456" "5705850" "5880524" "5923086").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/05 17:16
L30	132	25 and (solder near wet\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/05 18:05